

# NP119N04NUK

40 V – 120 A – N-channel Power MOS FET  
 Application: Automotive

R07DS1252EJ0100  
 Rev.1.00  
 Mar 30, 2015

## Description

The NP119N04NUK is N-channel MOS Field Effect Transistors designed for high current switching applications.

## Features

- Super low on-state resistance  
 $R_{DS(on)} = 2.15 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 60 \text{ A)}$
- Low  $C_{iss}$ :  $C_{iss} = 7400 \text{ pF TYP. (} V_{DS} = 25 \text{ V)}$
- Designed for automotive application and AEC-Q101 qualified

## Ordering Information

Part No.	Lead Plating	Packing	Package
NP119N04NUK-S18-AY *1	Pure Sn (Tin)	Tube 50 p/tube	TO-262 (MP-25SK)

Note: \*1 Pb-free (This product does not contain Pb in the external electrode)

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )	$V_{DSS}$	40	V
Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )	$V_{GSS}$	$\pm 20$	V
Drain Current (DC) ( $T_C = 25^\circ\text{C}$ )	$I_{D(DC)}$	$\pm 120$	A
Drain Current (pulse) *1	$I_{D(pulse)}$	$\pm 480$	A
Total Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_{T1}$	250	W
Total Power Dissipation ( $T_A = 25^\circ\text{C}$ )	$P_{T2}$	1.8	W
Channel Temperature	$T_{ch}$	175	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +175	$^\circ\text{C}$
Repetitive Avalanche Current *2	$I_{AR}$	56	A
Repetitive Avalanche Energy *2	$E_{AR}$	313	mJ

Notes: \*1  $T_C = 25^\circ\text{C}$ ,  $P_w \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

\*2  $R_G = 25 \Omega$ ,  $V_{GS} = 20 \text{ V} \rightarrow 0 \text{ V}$

## Thermal Resistance

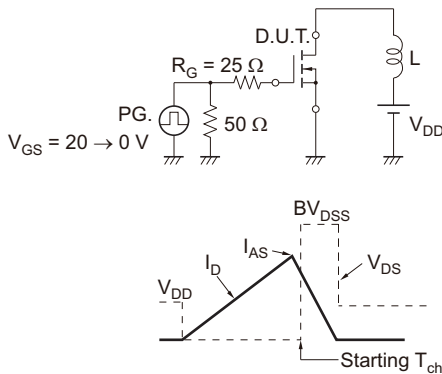
Channel to Case Thermal Resistance	$R_{th(ch-C)}$	0.60	$^\circ\text{C/W}$
Channel to Ambient Thermal Resistance	$R_{th(ch-A)}$	83.3	$^\circ\text{C/W}$

Electrical Characteristics (T<sub>A</sub> = 25°C)

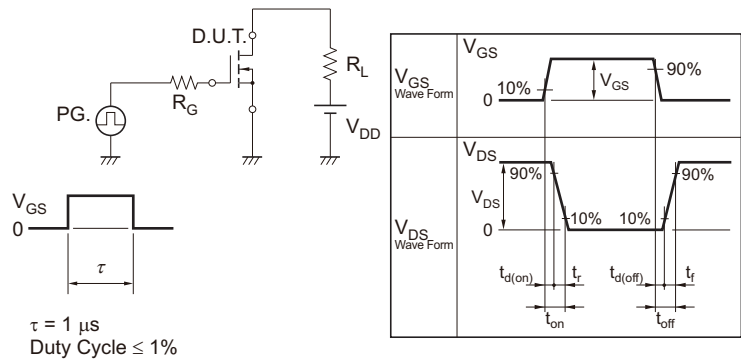
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V
Gate Leakage Current	I <sub>GSS</sub>	—	—	±100	nA	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	2.0	3.0	4.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA
Forward Transfer Admittance *1	y <sub>fs</sub>	50	114	—	S	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 60 A
Drain to Source On-state Resistance *1	R <sub>DS(on)</sub>	—	1.80	2.15	mΩ	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 60 A
Input Capacitance	C <sub>iss</sub>	—	7400	11100	pF	V <sub>DS</sub> = 25 V
Output Capacitance	C <sub>oss</sub>	—	1000	1500	pF	V <sub>GS</sub> = 0 V
Reverse Transfer Capacitance	C <sub>rss</sub>	—	390	710	pF	f = 1 MHz
Turn-on Delay Time	t <sub>d(on)</sub>	—	30	70	ns	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 60 A
Rise Time	t <sub>r</sub>	—	11	30	ns	V <sub>GS</sub> = 10 V
Turn-off Delay Time	t <sub>d(off)</sub>	—	105	210	ns	R <sub>G</sub> = 0 Ω
Fall Time	t <sub>f</sub>	—	13	40	ns	
Total Gate Charge	Q <sub>G</sub>	—	130	195	nC	V <sub>DD</sub> = 32 V
Gate to Source Charge	Q <sub>GS</sub>	—	32	—	nC	V <sub>GS</sub> = 10 V
Gate to Drain Charge	Q <sub>GD</sub>	—	31	—	nC	I <sub>D</sub> = 120 A
Body Diode Forward Voltage *1	V <sub>F(S-D)</sub>	—	0.9	1.5	V	I <sub>F</sub> = 120 A, V <sub>GS</sub> = 0 V
Reverse Recovery Time	t <sub>rr</sub>	—	56	—	ns	I <sub>F</sub> = 120 A, V <sub>GS</sub> = 0 V
Reverse Recovery Charge	Q <sub>rr</sub>	—	80	—	nC	di/dt = 100 A/μs

Note: \*1 Pulsed test

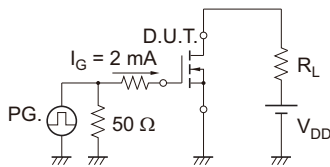
TEST CIRCUIT 1 AVALANCHE CAPABILITY



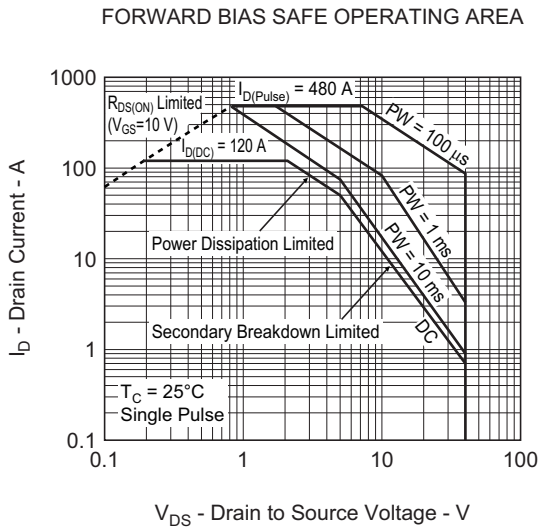
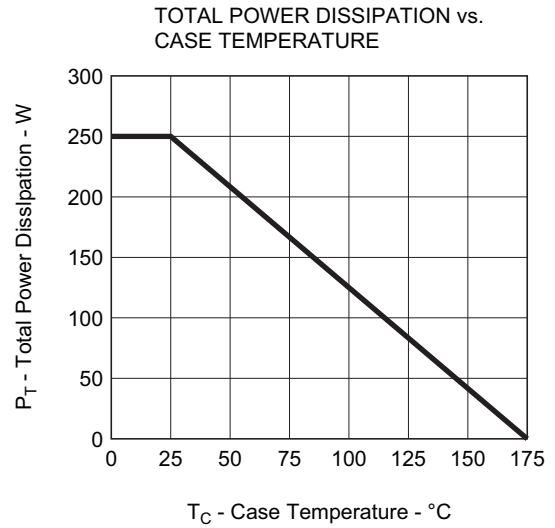
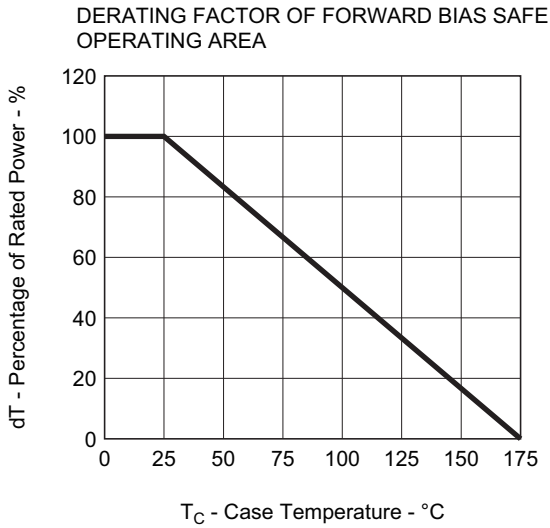
TEST CIRCUIT 2 SWITCHING TIME



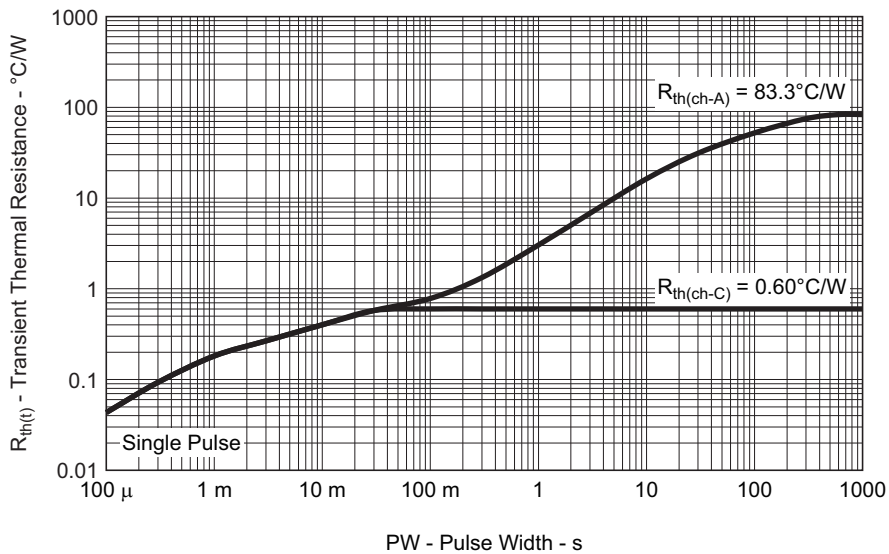
TEST CIRCUIT 3 GATE CHARGE



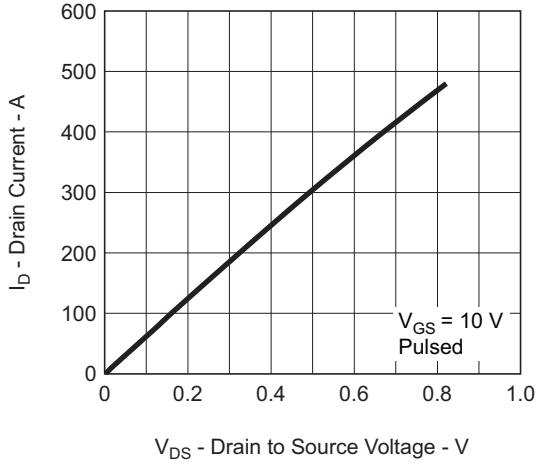
Typical Characteristics (T<sub>A</sub> = 25°C)



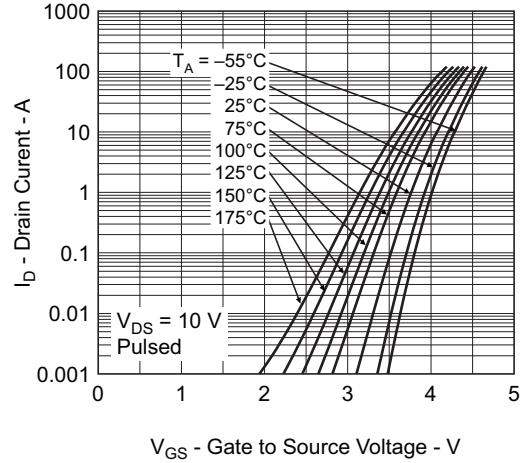
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



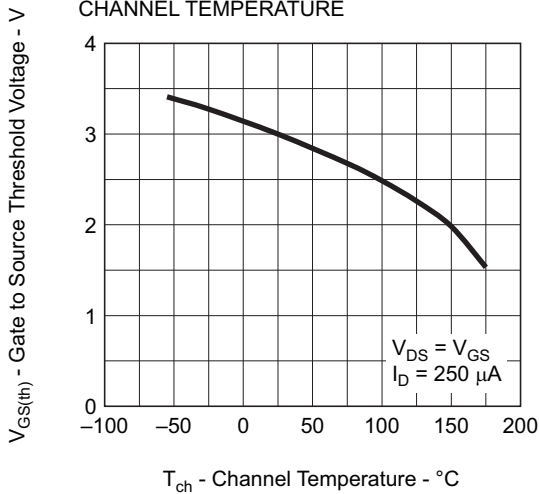
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



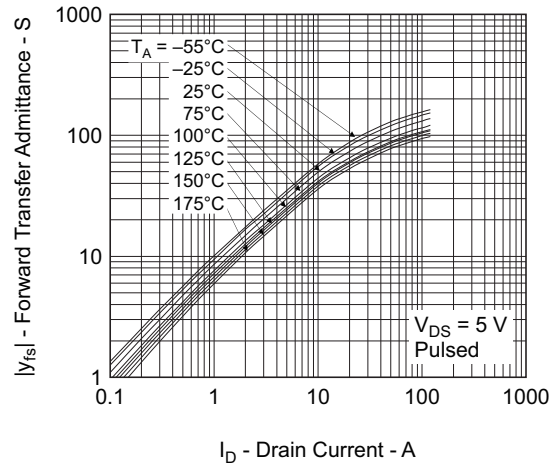
FORWARD TRANSFER CHARACTERISTICS



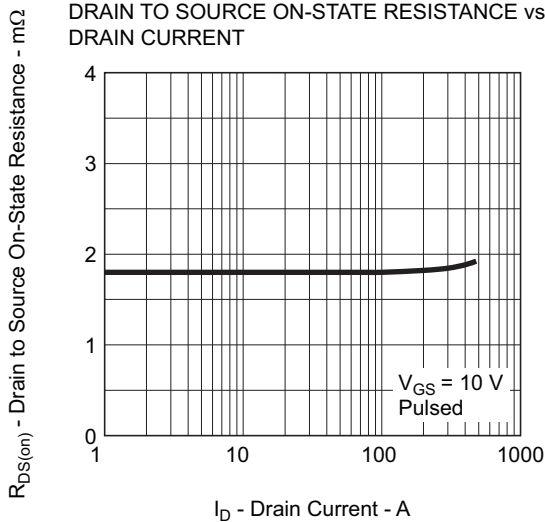
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



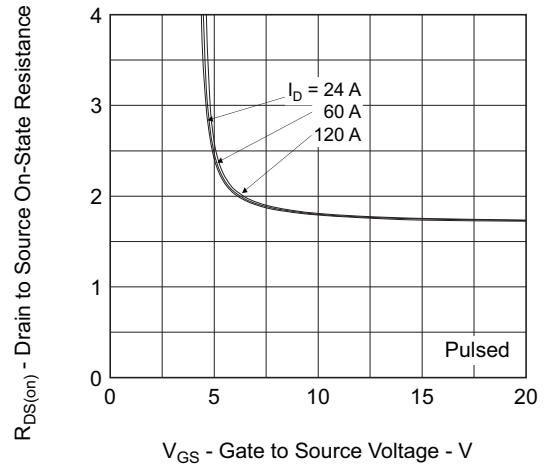
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



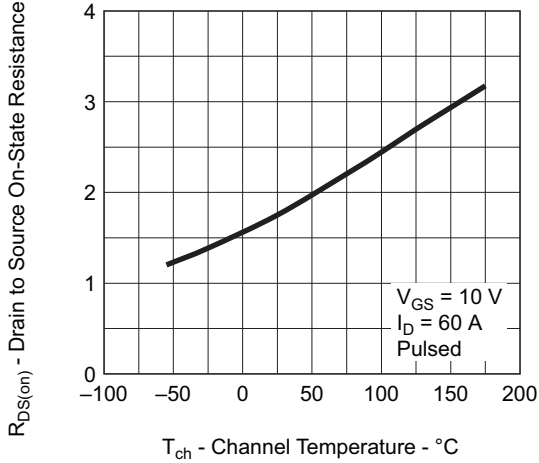
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



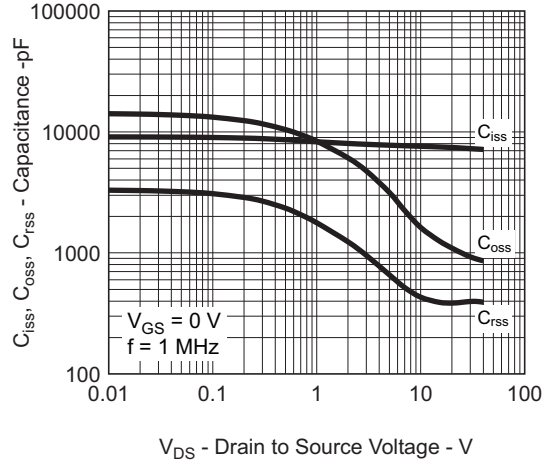
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



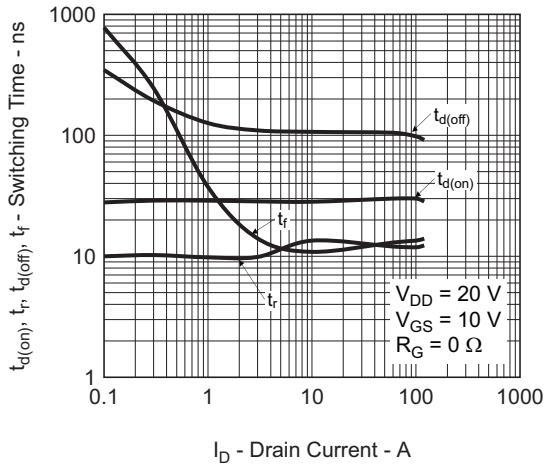
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



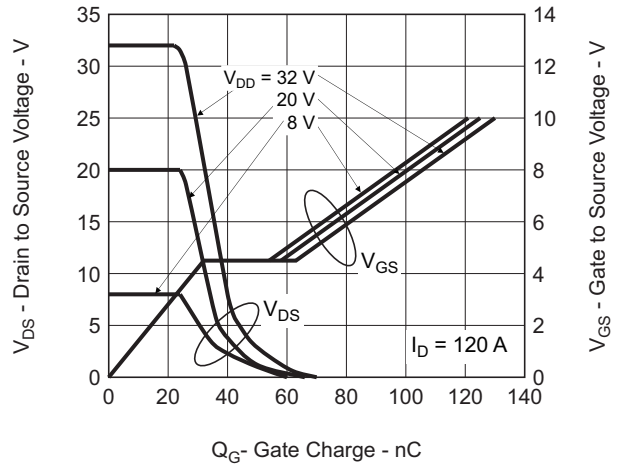
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



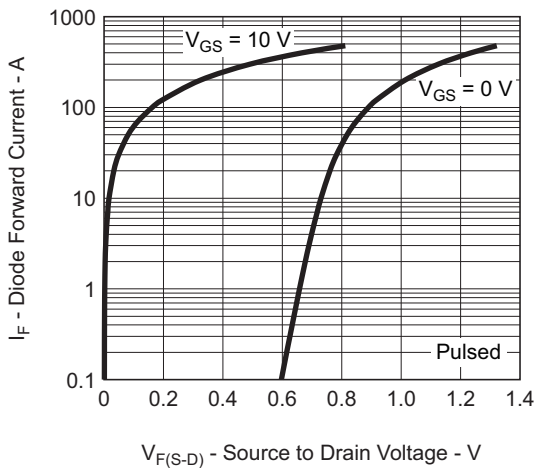
SWITCHING CHARACTERISTICS



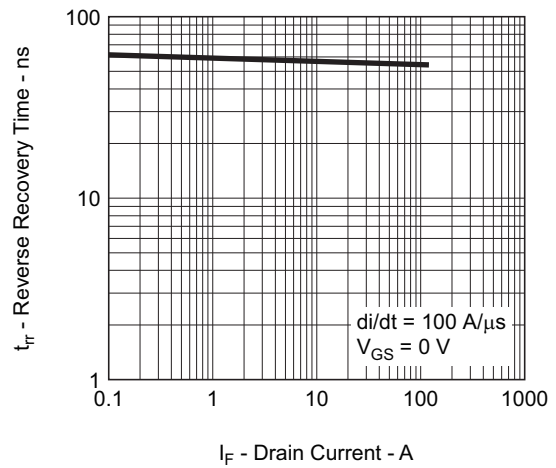
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



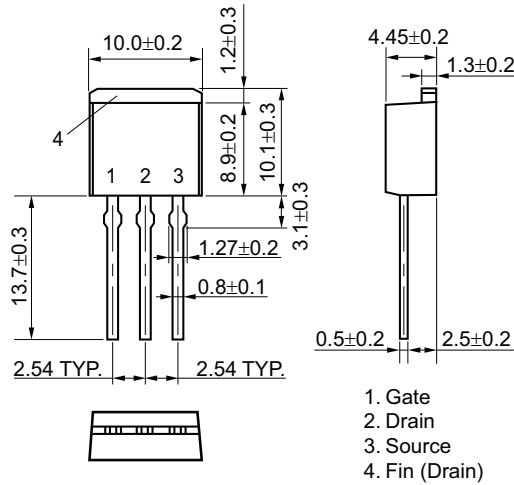
REVERSE RECOVERY TIME vs. DRAIN CURRENT



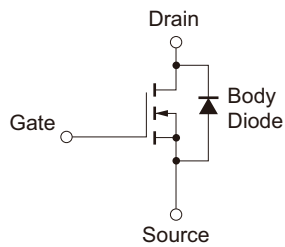
**Package Drawing (Unit: mm)**

**TO-262 (MP-25SK) (Mass: 1.8 g TYP.)**

Renesas Code: PRSS0004AM-A



**Equivalent Circuit**



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

<b>Revision History</b>	<b>NP119N04NUK Data Sheet</b>
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Rev.	Date	Description	
		Page	Summary
1.00	Mar 30, 2015	—	First Edition Issued

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